To:

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Facsimile Number: 703-872-9311

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### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

I Applicant:

Steinmann et al

Art Unit:

1765

Serial No.:

09/852,921

Examiner:

Deo. D.

Filing Date: 05/10/01

Docket No.: TI-29881

Title:

METHOD OF INTEGRATING A THIN FILM RESISTOR IN A

MULTI-LEVEL METAL TUNGSTEN-PLUG INTERCONNECT

### CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9311 on the date shown below:

Jacquelire

Barner, Reg. No. 36,144

September 11, 2003

Date

#### **FACSIMILE COVER SHEET**

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NEW APPLIC DECLARATIC ASSIGNMEN FORMAL DR. INFORMAL D	ON (# Pages) T (# Pages) AWINGS PRAWINGS ION APP'N (# Pages)	X AMENDMENT (10 Pages) X EOT 1mth (3 Pages) NOTICE OF APPEAL (# Pages) APPEAL (# Pages) ISSUE FEE (# Pages) REPLY BRIEF (IN TRIPLICATE) X RCE	
NAME OF INVENTOR(S):		RECEIPT DATE & SERIAL NO.:	RECEIVED
Steinmann		Serial No.: 09/852,921	RECEIVED CENTRAL FAX CENTER
TITLE OF INVENTION:		Filing Date: 05/10/2001	SEP 1 2 2003
Method of Integrating	a Thin Film Resistor		SEPI I D 2000
TI FILE NO.:	DEPOSIT ACCT. NO.:		
TI-29881	20-0668		
FAXED: 9/11/2003			ł
DUE: 3/31/2003			
ATTY/SECY: JJG		<u> </u>	<del></del>

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PTO/SB/30

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#### REQUEST FOR

## CONTINUED EXAMINATION (RCE) TRANSMITTAL

Subsection (b) of 35 U.S.C. § 132, effective on May 29, 2000, provides for continued exemination of an utility or plant application filed on or after June 8, 1995.

See The American Inventors Protection Act of 1999 (AIPA).

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Application Number	09/852,921			
Filing Date	05/10/01			
First Named Inventor	Steinmann			
Group Art Unit	1765			
Examiner Name	Deo, D			
Attorney Docket Number	TJ-29881			
		_		

This is a Request for Continued Examination (REC) under 37 C.F.R. § 1.114 of the above-identified application.

NOTE: 37 C.F.R. § 1.114 is effective on May 29, 2000. If the above-identified application was filed prior to May 29, 2000, applicant may wish to consider filing a continued prosecution application (CPA) under 97 C.F.R. § 1.53 (d) (PTO/SB/29) insteed of a RCE to be eligible for the patent term adjustment provisions of the AIPA. See Changes to Application Examination and provisional Application Practice, interim Rule, 66 Fad. Reg. 14965. (Mar. 20, 2000), 1233 Off. Gaz. Pat. Office 47 (Apr. 11, 2000), which established RCE practice.

1 s	ubmis	sion I	required under 37	C.F.R. § 1.114						
8		Pre	viously submitted							
	i.		Consider the amendments(s)/reply under 37 C.F.R. § 1.116 previously filed on							
	ij.		Consider the ar	arguments in the Appeal Brief or Reply Brief previously filed on						
	ül.	$\Box$	Other							
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•	j.	Ø		iment/Reply						
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	iii.		Information Dis		ent (IDS)					
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a	a Suspension of action on the above-identified application is requested under 37 C.F.R. § 1.103 (c) for a period of									
b	П	Othe	r							
3 F	883	The	e RCE fee under	37 C.F.R. § 1.1	7(e) is required by	37 C.F.R. § 1.1	14 when the RO	E is filed.		
سي <u>د</u> د	Ø	The	Director is hereb	y authorized to	charge the followi	ng fees, or credit	any overpayme	ents, to		
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METHOD OF INTEGRATING A THIN FILM RESISTOR IN A

MULTI-LEVEL METAL TUNGSTEN-PLUG INTERCONNECT

#### <u>Amendment</u>

Commissioner of Patents

P. O. Box 1450

Alexandria, VA 22313-1450

CERTIFICATION OF FACSIMILE TRANSMISSION

thereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9311

J. Garner, Reg. No. 36,144

September 11, 2003

Date

Dear Sir:

The following amendments and remarks are offered in response to the Examiner's Office Action dated 05/12/2003. They are respectfully submitted as a full and complete response to that Action.

Please amend the above-referenced application as follows:

There are no Amendments to the Specification.

Amendments to the Claims are reflected in the listing of claims that begin on page 3 of this paper.

There are no Amendments to the Drawings.

The Remarks begin on page 6.

PAGE 07

**Amendments to the Specification** 

None.